

STGW30NB60H

N-CHANNEL 30A - 600V TO-247 PowerMESHTM IGBT

TYPE	V _{CES}	V _{CE(sat)}	Ι _C					
STGW30NB60H	600 V	< 2.8 V	30 A					

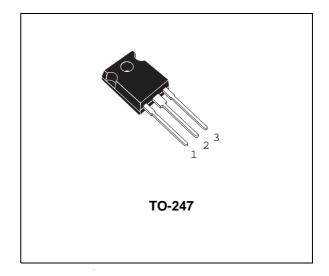
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (V_{CESAT})
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- VERY HIGH FREQUENCY OPERATION
- OFF LOSSES INCLUDE TAIL CURRENT

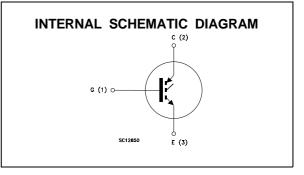
DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding perfomances. The suffix "H" identifies a family optimized to achieve very low switching times for high frequency applications (<120kHz).

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- WELDING EQUIPMENTS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES





Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V
VECR	Emitter-Collector Voltage	20	V
V_{GE}	Gate-Emitter Voltage	± 20	V
Ιc	Collector Current (continuous) at $T_c = 25$ °C	60	А
Ιc	Collector Current (continuous) at $T_c = 100$ °C	30	А
I _{CM} (●)	Collector Current (pulsed)	240	А
P _{tot}	Total Dissipation at $T_c = 25 \ ^{\circ}C$	190	W
	Derating Factor	1.52	W/°C
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

ABSOLUTE MAXIMUM RATINGS

(•) Pulse width limited by safe operating area

THERMAL DATA

ſ	R _{thj-case}	Thermal	Resistance	Junction-case	Max	0.66	°C/W
	R _{thj-amb}	Thermal	Resistance	Junction-ambient	Max	30	oC/W
	R _{thc-h}	Thermal	Resistance	Case-heatsink	Тур	0.1	°C/W

ELECTRICAL CHARACTERISTICS (T_j = 25 $^{\circ}$ C unless otherwise specified) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-Emitter Breakdown Voltage	$I_{C} = 250 \ \mu A$ $V_{GE} = 0$	600			V
I _{CES}	Collector cut-off (V _{GE} = 0)				10 100	μΑ μΑ
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20 \text{ V} \qquad \qquad V_{CE} = 0$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$V_{\text{GE(th)}}$	Gate Threshold Voltage	$V_{CE} = V_{GE}$ I _C = 250 µA	3		5	V
V _{CE(SAT)}		$ \begin{array}{lll} V_{GE} = 15 \ V & I_C = 30 \ A \\ V_{GE} = 15 \ V & I_C = 30 \ A & T_j = 125 \ ^oC \end{array} $		2.2 1.8	2.8	V V

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g fs	Forward Transconductance	V _{CE} =25 V I _C = 30 A		20		S
Cies C _{oes} Cres	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25 V$ f = 1 MHz $V_{GE} = 0$		2300 250 60		pF pF pF
Q _G Q _{GE} Q _{GC}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CE} = 480 \text{ V}$ I _C = 30 A V _{GE} = 15 V		150 15 72		nC nC nC
I _{CL}	Latching Current		120			A

SWITCHING ON

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Delay Time Rise Time	V _{CC} = 480 V V _{GE} = 15 V	I _C = 30 A R _G = 10Ω		15 75		ns ns
(di/dt) _{on}	Turn-on Current Slope	V _{CC} = 480 V R _G = 10 Ω	I _C = 30 A V _{GE} = 15 V		760		A/µs
Eon	Turn-on Switching Losses	T _j = 125 °C			850		μJ

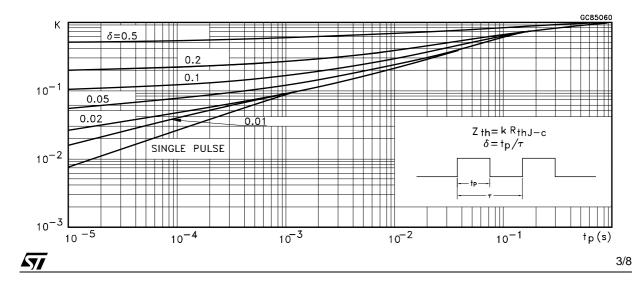
57

ELECTRICAL CHARACTERISTICS (continued) SWITCHING OFF

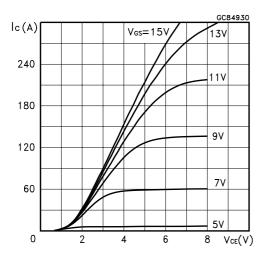
Symbol	Parameter	Test Co	nditions	Min.	Тур.	Max.	Unit
t _c t _r (v _{off})	Cross-Over Time Off Voltage Rise Time	V _{CC} = 480 V R _{GE} = 10 Ω	I _C = 30 A V _{GE} = 15 V		150 40		ns ns
t _{d(off}) t _f	Delay Time Fall Time				210 90		ns ns
E _{off} (**) E _{ts}	Turn-off Switching Loss Total Switching Loss				1.10 1.8		mJ mJ
t_c $t_r(v_{off})$	Cross-Over Time Off Voltage Rise Time Delay Time	VCC = 480 V R _{GE} = 10 Ω T _i = 125 °C	I _C = 30 A V _{GE} = 15 V		250 70 250		ns ns
t _{d(off)} t _f E _{off} (**)	Fall Time Turn-off Switching Loss	1) = 125 C			160 1.6		ns ns mJ
Ets	Total Switching Loss				2.45		mJ

(•) Pulse width limited by max. junction temperature (*) Pulsed: Pulse duration = $300 \ \mu$ s, duty cycle 1.5 % (**)Losses Include Also The Tail (Jedec Standardization)

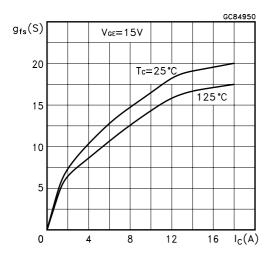
Thermal Impedance



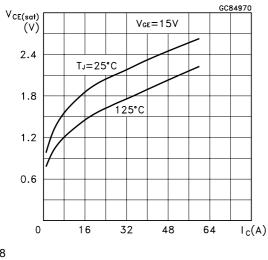
Output Characteristics



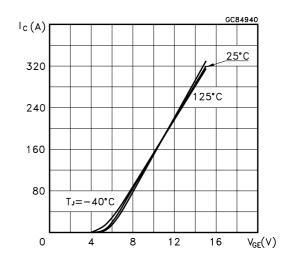
Transconductance



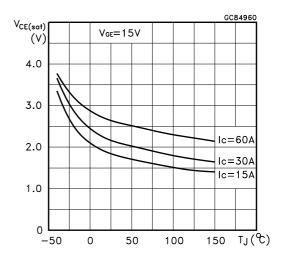
Collector-Emitter On Voltage vs Collector Current

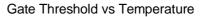


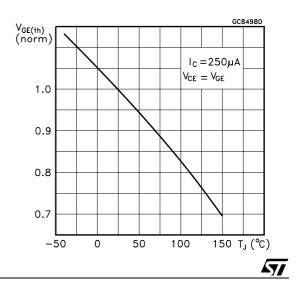
Transfer Characteristics

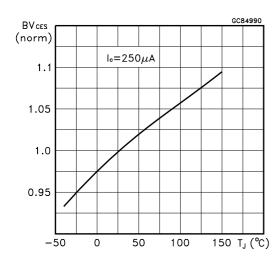


Collector-Emitter On Voltage vs Temperature









 $V_{CE} = 480V$ $I_{C} = 30A$ GC85010

Gate Charge vs Gate-Emitter Voltage

 $V_{GE}(V)$

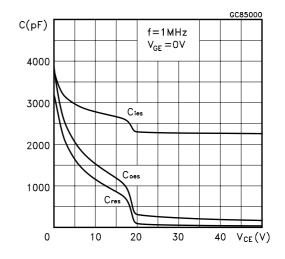
20

15

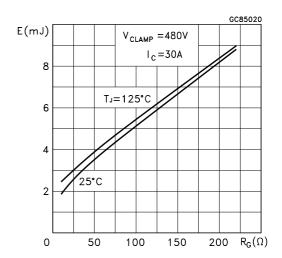
10

Normalized Breakdown Voltage vs Temperature

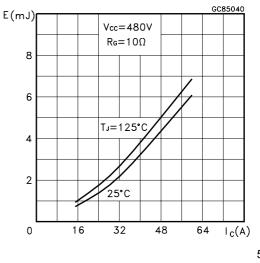
Capacitance Variations

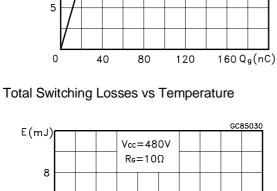


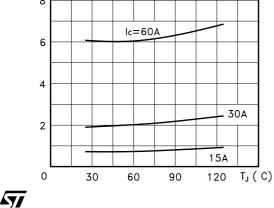
Total Switching Losses vs Gate Resistance



Total Switching Losses vs Collector Current







5/8

Switching Off Safe Operating Area

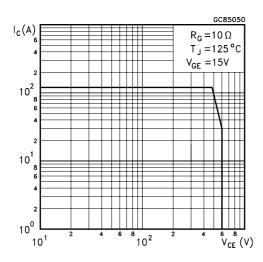


Fig. 1: Gate Charge test Circuit

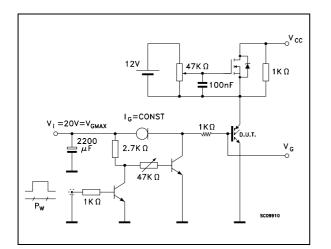


Fig. 2: Test Circuit For Inductive Load Switching

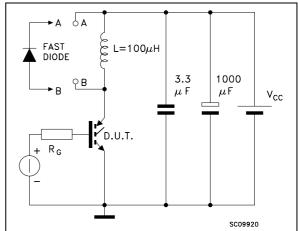
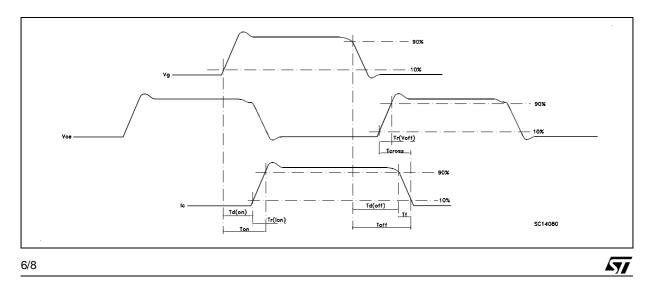
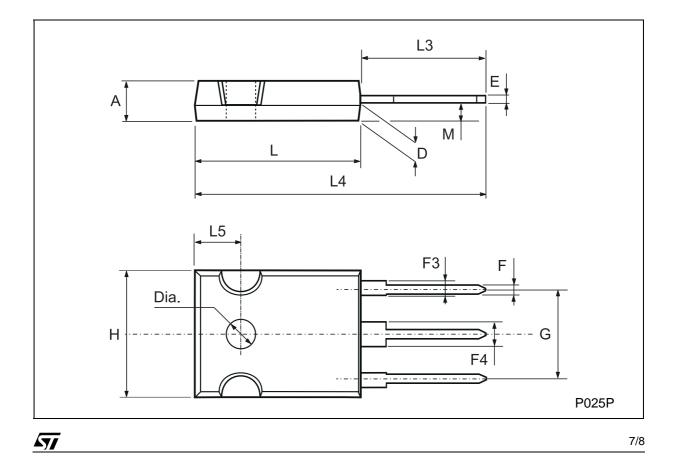


Fig. 3 Switching Waveforms



DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.7		5.3	0.185		0.209
D	2.2		2.6	0.087		0.102
E	0.4		0.8	0.016		0.031
F	1		1.4	0.039		0.055
F3	2		2.4	0.079		0.094
F4	3		3.4	0.118		0.134
G		10.9			0.429	
Н	15.3		15.9	0.602		0.626
L	19.7		20.3	0.776		0.779
L3	14.2		14.8	0.559		0.582
L4		34.6			1.362	
L5		5.5			0.217	
М	2		3	0.079		0.118





Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specification mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics. The ST logo is a trademark of STMicroelectronics

> © 1999 STMicroelectronics - Printed in Italy - All Rights Reserved STMicroelectronics GROUP OF COMPANIES

Australia - Brazil - China - Finland - France - Germany - Hong Kong - India - Italy - Japan - Malaysia - Malta - Morocco -Singapore - Spain - Sweden - Switzerland - United Kingdom - U.S.A.

http://www.st.com

8/8

A7